

< X/Ku band internally matched power GaAs FET >

MGFK35V4045

14.0 - 14.5 GHz BAND / 3.5W

DESCRIPTION

The MGFK35V4045 is an internally impedance-matched GaAs power FET especially designed for use in 14.0 – 14.5 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

Internally matched to 50(ohm) system Flip-chip mounted

- High output power
 - P1dB=3.5W (TYP.) @f=14.0 14.5GHz
- High linear power gain
 GLD 6 44B (TVD) @
 - GLP=6.4dB (TYP.) @f=14.0 14.5GHz
- High power added efficiency
 - P.A.E.=20% (TYP.) @f=14.0 14.5GHz

APPLICATION

• 14.0 - 14.5 GHz band power amplifiers

QUALITY GRADE

• IG

RECOMMENDED BIAS CONDITIONS

• VDS=10V • ID=1.2A Refer to Bias Procedure

Absolute maximum ratings (Ta=25°C)

Symbol	Parameter	Ratings	Unit
VGDO	Gate to drain breakdown voltage	-15	V
VGSO	Gate to source breakdown voltage	-15	V
ID	Drain current	3500	mA
IGR	Reverse gate current	-9	mA
IGF	Forward gate current	17	mA
PT *1	Total power dissipation	33.3	W
Tch	Cannel temperature	175	°C
Tstg	Storage temperature	-65 to +175	°C

*1: Tc=25°C

OUTLINE DRAWING Unit: millimeters (inches) 16.0 ± 0.3 (0.630 ± 0.012) 2MIN. (0.079MIN.) 0.6 ± 0.15 (0.024 ± 0.006) (0.256+0.004) 6.5 +0.1 R1.25 ທ (R0.049)ທີ່ 2MIN. (0.079MIN.) (3) 0.6 ± 0.15 (0.024 ± 0.006) 9.0 (0,354) 13.0 ± 0.2 (0.512 ± 0.008) (0.004) (0.043)2.9 ± 0.4 114 ± 0.016) 10.0 (0.394) (i) GATE 2 SOURCE 3 DRAIN GF-14

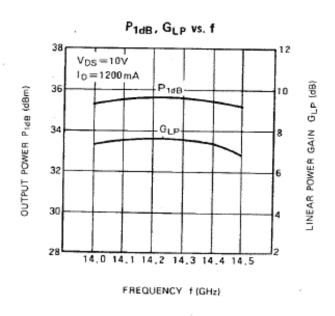
Keep Safety first in your circuit designs! Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measure such as (I) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

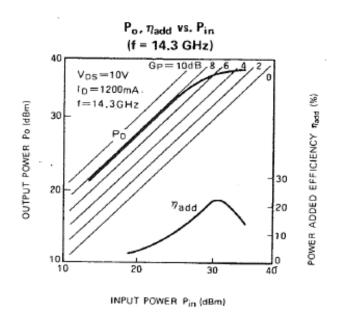
Electrical characteristics (Ta=25°C)

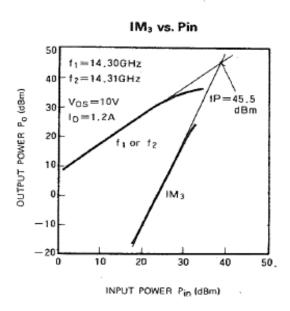
Symbol	Parameter	Test conditions	Limits		Unit	
			Min.	Тур.	Max.	
IDSS	Saturated drain current	VDS=3V,VGS=0V	2000	2700	3500	mA
gm	Transconductance	VDS=3V,ID=1200mA	700	1000	-	mS
VGS(off)	Gate to source cut-off voltage	VDS=3V,ID=10mA	-2	-	-5	٧
P1dB	Output power at 1dB gain compression	VDS=10V,ID(RF off)=1200mA	34.5	35.4	-	dBm
GLP	Linear Power Gain	f=14.0 – 14.5GHz	5.5	6.4	-	dB
PAE	Power added efficiency		-	20	-	%
Rth(ch-c) *2	Thermal resistance	delta Vf method	-	=	4.5	°C/W

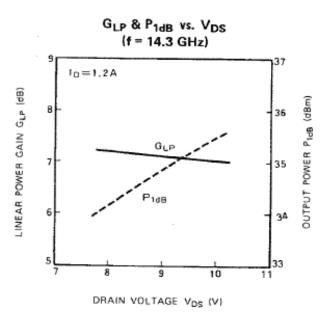
*2 : Channel-case

MGFK35V4045 TYPICAL CHARACTERISTICS

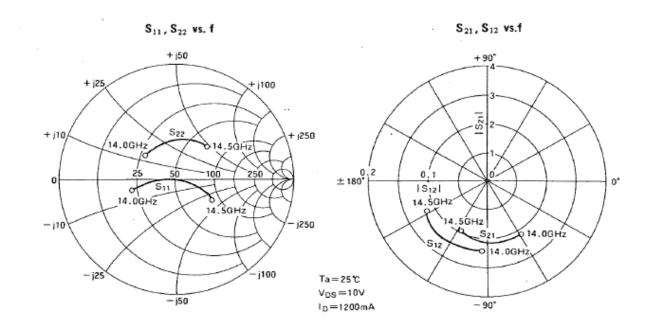








MGFK35V4045 S-parameters(Ta=25deg.C , VDS=10(V),IDS=1200(mA))



f (GHz)	S Parameters(Typ.)							
	S11		S21		S12		S22	
	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)
14.0	0.391	-164	2.089	-58	0.137	-94	0.324	139
14.1	0.224	-173	2.163	-70	0.139	-105	0.322	117
14.2	0.091	176	2.188	-82	0.141	-118	0.331	98
14.3	0.052	-3	2.163	-93	0.143	-130	0.342	78
14.4	0.052	-22	2.113	-105	0.140	-141	0.362	62
14.5	0.337	-32	1.995	-117	0.127	-152	0.397	47

Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

- •These materials are intended as a reference to assist our customers in the selection of the Mitsubishi semiconductor product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Mitsubishi Electric Corporation or a third party.
- •Mitsubishi Electric Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
- •All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Mitsubishi Electric Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor for the latest product information before purchasing a product listed herein.
- The information described here may contain technical inaccuracies or typographical errors. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
- Please also pay attention to information published by Mitsubishi Electric Corporation by various means, including the Mitsubishi Semiconductor home page (http://www.MitsubishiElectric.com/).
- •When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
- •Mitsubishi Electric Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- •The prior written approval of Mitsubishi Electric Corporation is necessary to reprint or reproduce in whole or in part these materials.
- •If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
- Any diversion or re-export contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
- •Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor for further details on these materials or the products contained therein.